

NFC/RFID Controller

SPECIFICATION

1 FEATURES

- UMC CMOS 180 nm technology
- Complete RFID reader solution, including RF front-end and 8051-based MCU
- Supports ISO14443A* and ISO14443B standards in both reader and card emulation mode
- Supports NFC Initiator in both Active and Passive modes with speeds 212 and 424 Kbps
- Supports NFC Target in both Active and Passive modes with speeds 212 and 424 Kbps
- Supports ISO15693 standard in reader mode
- Supports high-speed transmissions up to 848 Kbps
- "On the fly" 8051 firmware downloading via USB interface (controlled by driver for Windows)
- Possibility of boot from SPI flash
- Sleep mode with ultra-low power consumption (<1 μA)
- Wake-up with programmable RF field level
- SPI interface in stand-alone configuration
- Dual channel receiver architecture for elimination of "blind spots"
- Integrated voltage regulators for analog and digital parts and I/O
- DES crypto co-processor
- AES crypto co-processor
- CRYPTO1 co-processor
- SWP interface
- ISO7816 interface

2 APPLICATIONS

- Mobile devices (tablets, handsets)
- Secure pairing (Bluetooth, Wi-Fi, other paired wireless networks)
- Public transport or event ticketing
- Passport or payment (POS) reader systems
- Short-range wireless communication tasks (firmware updates)
- Product identification or authentication
- Medical equipment or consumables
- Access control, digital door locks
- Sharing of electronic business cards

3 OVERVIEW

NT1046 is a single-chip RFID reader solution. It is composed of an integrated RF front-end, RFID framing engine supporting ISO15693, ISO14443A*, ISO14443B and NFCIP standards, 128-byte FIFO, 8051-based MCU with full-speed USB 2.0 compliant interface, and RAM for 8051 code and data.



This IC also can be used for adding NFC functionality to mobile devices and other applications, using integrated MCU to perform high-level RFID protocol tasks. NT1046 can perform in one of three modes: RFID/NFC reader, NFC Peer, or Card Emulation mode.

Firmware for 8051 MCU can be downloaded via USB interface on device plug-in. This feature significantly simplifies firmware updates. Alternatively, MCU can detect presence of an SPI flash and boot from it.

Extension of standards set and implementation of custom RFID protocols can be achieved by using direct modes with MCU-controlled bit coding and framing. Direct access to RF Frontend control registers allows fine tuning of various parameters at physical layer.

- * The costs of intellectual property licenses under applicable patents belonging to NXP Semiconductors are not included in this NTLab product. If you plan to use and/or enable the ISO/IEC 14443A protocol please contact NXP Semiconductors for the appropriate patent license via an inquiry to the following:
 - NXP Semiconductors
 - Intellectual Property & Licensing Department

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4 STRUCTURE

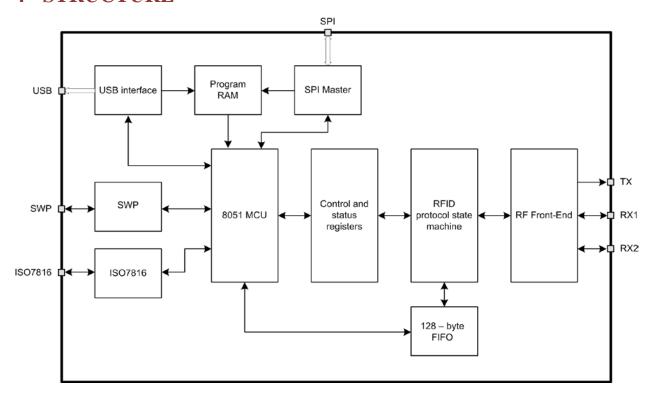


Figure 1: NT1046 NFC IC structure.



5 PIN DESCRIPTION

Name	Direction	Description		
V_in	IO	External supply		
Vdd_a	О	Internal regulated supply for analog part		
Vdd_io	О	Internal regulated supply for I/O		
Vdd_rf	О	Internal supply for RF power amplifier		
Vdd_pa	I	Supply input for power RF power amplifier		
TX_OUT	О	RF power amplifier output		
RX_IN1	I	Main RX input		
RX_IN2	I	Auxiliary RX input		
SWP	IO	SWP line		
DP	IO	USB D+ line		
DM	IO	USB D- line		
SS	0	Slave Select SPI output		
DATA_CLK	О	SPI clock output		
MOSI	0	SPI data output		
MISO	I	SPI data intput		
EN	I	Chip Enable input		
GPIO0	IO	Multi-purpose digital inout		
GPIO1	IO	Multi-purpose digital inout		
GPIO4	IO	Multi-purpose digital inout		
GPIO5	IO	Multi-purpose digital inout		
GPIO6	IO	Multi-purpose digital inout		
GPIO7	IO	Multi-purpose digital inout		
OSC_OUT	О	Crystal or oscillator output		
OSC_IN	I	Crystal or oscillator input		
GND	IO	Ground		

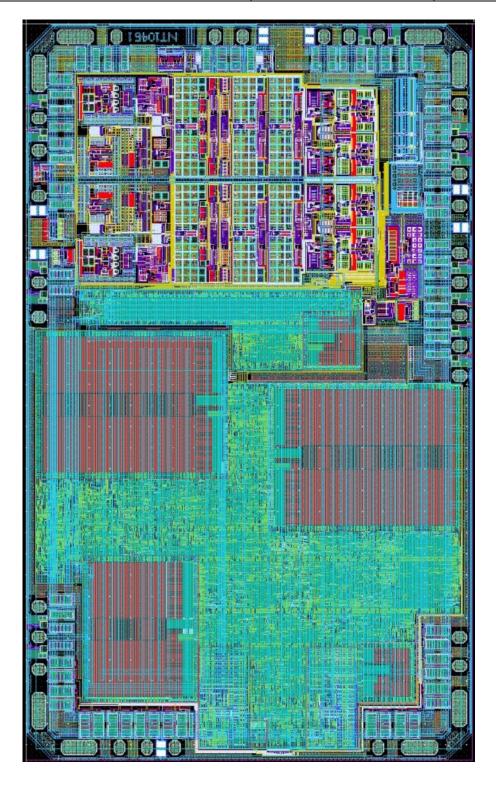


6 LAYOUT DESCRIPTION

The IC dimensions are given in the table 1.

Table 1: IC dimensions.

Dimension	Value	Unit	
Height	3005	μm	
Width	1840	μm	





7 OPERATION CHARACTERISTICS

7.1 TECHNICAL CHARACTERISTICS

Technology	UMC CMOS 180 nm
Status	silicon proven
Area	5.53 mm^2

7.2 OPERATING CONDITIONS

Parameter	Symbol	Value			Unit
Parameter		min	typ.	max	Unit
Operating input voltage	V_{in}	2.7	3.3	3.6	V
Operating ambient temperature	T_a	-40	27	85	°C

8 DELIVERABLES

IP contents:

- Datasheet
- Layout View (GDSII)
- Evaluation kit based on packaged IC
- Characterization Report
- Behavioral Model
- SPICE netlist (.cdl)
- Integration Support

REVISION HISTORY

From version 1.2:

- Section 1 updated
- Section 2 updated

From version 1.1:

- Section 1 updated
- Section 2 updated